

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20190424001.1A Qualification of DMOS6 as an additional Wafer Fab Site option for select devices Change Notification / Sample Request

Date: Dec 09, 2019

Dear Customer:

The purpose of PCN Revision A is to add clarification to the Description of Change that was included in the original PCN letter.

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

The customer should acknowledge receipt of this notification by email within **30** days of the date of receipt. Lack of acknowledgement of this notice within 30 days constitutes customer acceptance of the change.

Samples or additional data to support customer evaluation must be requested within 30 days of receipt of this notification. If samples are requested for evaluation the customer must provide evaluation results within the sample evaluation period indicated on page 3 of this notification. The Sample Evaluation Period begins on the date the customer receives samples from TI.

If the customer approved the change TI can proceed with implementation of the change. The proposed first ship date is shown on page 3.

If the customer does not approve the PCN or the approval response is not provided within the Sample Evaluation Period, TI can implement the change, but the customer may elect to place an order for unchanged product by the Last Time Buy Date for delivery by the Last Time Ship Date. TI cannot guarantee that shipments to the customer after any last time order is delivered will not include the changed material. If the customer places an order with delivery after the Last Time Shipment Date, the order may be fulfilled with changed material or any material processed to TI specifications at that future time.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team (<u>PCN_www_admin_team@list.ti.com</u>). For sample requests or sample related questions, contact your field sales representative.

PCN Team SC Business Services

20190424001.1<mark>A</mark> Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE AFE4420YZR AFE4420YZR **CUSTOMER PART NUMBER**

38140318 99055ULR

Technical details of this Product Change follow on the next page(s).

PCN Number:		201904	124001.1 <mark>A</mark>	PCN Date:		ate:	Dec. 9, 2019	
Title	Qualification of Technology	DMOS6	MOS6 as an additional Wafer Fab Site option for select devices in LBC8					
Cus	tomer Contact:	PCN	<u>l Manager</u>	Dept:			Quality Services	
Pro	posed 1 st Ship Date	e: Jul	29, 2019	Sample Eval Period:			: 180 Days	
Last Time Buy Date:			29, 2019	Last Time Ship Date:			Mar 29, 2020	
Change Type:								
	Assembly Site		Assembly Prod	ess		Asse	Assembly Materials	
	Design		Electrical Specification			Mechanical Specification		
Test Site			Packing/Shipping/Labeling			Test Process		
☐ Wafer Bump Site			Wafer Bump Material			Wafer Bump Process		
			Wafer Fab Materials			Wafe	er Fab Process	
	<u>-</u>		Part number c	hange			<u>-</u>	
PCN Details								

Description of Change:

Texas Instruments is pleased to announce the qualification of its DMOS6 fabrication facility as an additional Wafer Fab source for the selected devices listed in "Product Affected" section. Device ID used by customer will read back as either 0x1B and 0x2B.

	Current Sites		Additional Sites			
Current Fab Site			Additional Fab Site			
RFAB	LBC8	300mm	DMOS6	LBC8	300mm	

Qual details are provided in the Qual Data Section.

Reason for Change:

Continuity of Supply

Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):

None

Changes to product identification resulting from this PCN:

Current

Chip Site	Chip Site Origin (20L)	Chip Site Country Code (21L)	Chip Site City
RFAB	RFB	USA	Richardson

New Fab Site

Chip Site	Chip Site Origin (20L)	Chip Site Country Code (21L)	Chip Site City
DMOS6	DM6	USA	Dallas

Sample product shipping label (not actual product label)





(1P) SN74LS07NSR (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY(1T) 7523483S12 (P) (20L) CSO: SHE (21L) CCO:USA (22L) ASO: MLA (23L) ACO: MYS

Product Affected Group:

AFE4420YZR

Qualification Report

Approve Date 22-Mar-2019

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: <u>AFE4420Y</u> <u>ZR</u>	QBS Product Reference: <u>AFE4420YZ</u> <u>R</u>	QBS Process Reference: CD3700A0YK HR	QBS Process Reference: CD3700A0YKH R	QBS Process Reference: PCD3258A00DY FPR (DM6/JCAP)	QBS Package Reference: LM3566YFF R
ED	Electrical Characterization	Per Datasheet Parameters	1/30/0	1/30/0	-	3/90/0	-	3/90/0
CDM	ESD - CDM	1000 V	-	-	2/6/0	1/3/0	1/3/0	-
CDM	ESD - CDM	1500 V	-	1/3/0	-	-	-	3/9/0
HBM	ESD - HBM	1500 V	1/3/0	1/3/0	-	-	-	-
HBM	ESD - HBM	2500 V	-	-	2/6/0	1/3/0	1/3/0	3/9/0
LU	Latch-up	(per JESD78)	-	1/6/0	-	-	-	-
HTOL	Life Test, 140C	480 Hours	-	-	2/154/0	4/180/0	-	-
HTOL	Life Test, 150C	500 Hours	1/77/0	1/77/0	-	-	-	-
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	1/77/0	1/77/0	1/77/0	-
HTSL	High Temp Storage Bake 170C	420 Hours	-	-	-	-	-	3/164/0
UHAST	Unbiased HAST 130C/85%RH	96 Hours	-	-	1/77/0	1/77/0	-	2/231/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	1/77/0	1/77/0	-	3/231/0
TC	Temperature Cycle, -65/150C	500 Cycles	-	-	-	-	-	3/231/0
TC	Temperature Cycle, -55/125C	700 Cycles	-	-	1/77/0	1/77/0	-	-
PD	Physical Dimensions	(per mechanical drawing)	-	-	1/30/0	1/20/0	-	-
SBS	Bump-shear	36 bumps / min 5 units per lot	-	-	1/30/0	1/5/0	-	-
SD	Pb Free Surface Mount Solderability	Pb Free/Solde r-	-	-	-	1/22/0	-	-

- QBS: Qual By Similarity
- Qual Device AFE4420YZR is qualified at LEVEL1-260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free (SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN www admin team@list.ti.com

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